

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
NEIL S. SASAKI	08/18/2014
SAMUEL LEE	08/18/2014
ANKIT K. MEHTA	08/20/2014
CRAIG E. LAUCHNER	08/18/2014
RECEIVING PARTY DATA	
Name:	KYPHON SÀRL
Street Address:	PIERRE-À-BOT 97
City:	NEUCHÂTEL
State/Country:	SWITZERLAND
Postal Code:	2000
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14466464
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NAME OF SUBMITTER:	ROBERT T. BARKER
SIGNATURE:	/Robert T. Barker/
DATE SIGNED:	08/25/2014
Total Attachments: 2	
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ASSIGNMENT

WHEREAS,

- | | | |
|-----|-------------------|--|
| (1) | Neil S. Sasaki | of the City of San Jose
State of California, USA |
| (2) | Samuel Lee | of the City of San Francisco
State of California, USA |
| (3) | Ankit K. Mehta | of the City of Santa Clara
State of California, USA |
| (4) | Craig E. Lauchner | of the City of Mountain View
State of California, USA |

has invented certain improvements in

METHODS OF FILLING BONE USING BONE CEMENT MIXING AND DELIVERY DEVICES

for which we have executed an application for Letters Patent of the United States of America,

_____ of even date herewith; and

_____X_____ filed on 08/22/2014 and assigned application number 14/466,464; and

WHEREAS, we hereby authorize and request the attorneys of Assignee, Kyphon SÀRL of Pierre-à-Bot 97, 2000 Neuchatel, Switzerland, to insert the filing date and application number of the application when known; and

WHEREAS, Kyphon SÀRL (Assignee), a limited liability company organized and existing under the laws of Switzerland, having its principal office and place of business at Pierre-à-Bot 97, 2000 Neuchatel, Switzerland, is desirous of obtaining the entire right, title, and interest in, to and under the invention and the application in the United States of America and in any and all countries foreign thereto;

NOW, THEREFORE, for One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the Assignee, its successors, legal representatives, and assigns, the entire right, title, and interest in, to and under the invention, and the application, and all divisional, renewal, substitutional, and continuing applications thereof, and all Letters Patent of the United States of America which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may be filed for the invention in any country or countries foreign to the United States of America, and all extensions, renewals, and reissues thereof, and all prior patents and patent applications for which a filing priority of the above-described patent application may be obtained, including the right to collect past damages; and we hereby authorize and request the Commissioner of Patents of the United States of America, and any official of any country or countries foreign to the United States of America, whose duty is to issue patents on applications as aforesaid, to issue all Letters Patent for the invention to the Assignee, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that we will communicate to the Assignee, its successors, legal representatives and assigns, any facts known to me respecting the invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid the Assignee, its successors, legal representatives and assigns, to obtain and enforce patent protection for the invention in all countries.

Inventor Name:
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Dated: AUG 15, 2014


Inventor Signature

Inventor Name:
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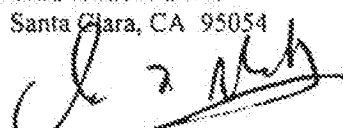
Dated: 16 AUG 2014


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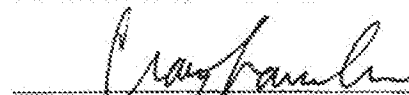
Dated: 20 Aug. 2014


Inventor Signature

Inventor Name:
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Dated: AUG 18, 2014


Inventor Signature